99-2 Preliminary Syllabus, Da-Yeh Univ

Information			
Title	半導體實驗	Serial No. / ID	1666 / EEI4208
Dept.	電機工程學系	School System / Class	大學日間部3年1班
Lecturer	張永平	Full or Part-time	兼任
Required / Credit	Required / 1	Graduate Class	No
Time / Place	(—)9AB / H371	Language	Chinese

Introduction

To provide students with hands-on experience of semiconductor fabrication so that students can have a better understanding on the subjects of various semiconductor fabrication techniques.

Outline

Vacuum Pump and Systems; Wafer Sheet Resistance; Wafer Cleaning; Thin Film Deposition; Surface Morphology; Thermal Oxidation; Chemical Etching; Selective Doping

Prerequisite

VLSI Technology